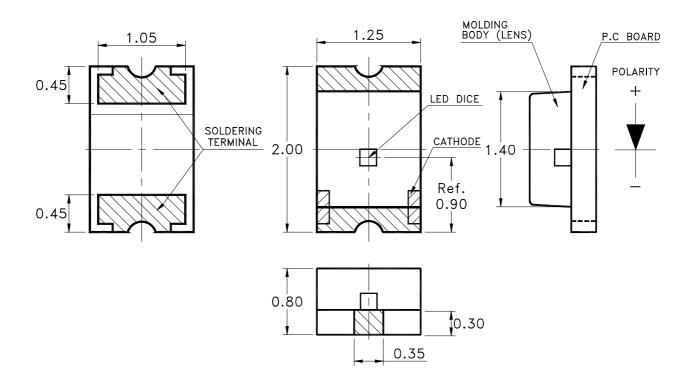


Property of Lite-On Only

Features

- * Super thin (0.80H mm) Chip LED.
- * Package in 8mm tape on 7" diameter reels.
- * Compatible with automatic placement equipment.
- * Compatible with infrared and vapor phase reflow solder process.
- * EIA STD package.
- * I.C. compatible.

Package Dimensions



Part no.	Lens	Source Color
LTST-C171TGKT	Water Clear	GaN Green

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.1 mm (.004") unless otherwise noted.

Part No.: LTST-C171TGKT	Page:	1	of	9	
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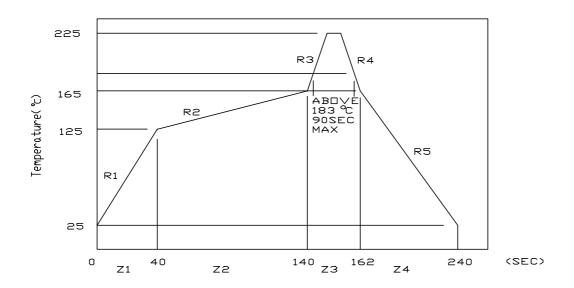
Property of Lite-On Only

Maximum Ratings At Ta=25℃ **Absolute**

Parameter	LTST-C171TGKT	Unit	
Power Dissipation	120	mW	
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	100	mA	
Continuous Forward Current	20	mA	
Derating Linear From 25°C	0.25	mA/°C	
Reverse Voltage	5	V	
Electrostatic Discharge Threshold(HBM) ^{Note A}	300	V	
Operating Temperature Range	-20°C to + 80°C		
Storage Temperature Range	-30°C to + 100°C		
Wave Soldering Condition	260°C For 5 Seconds		
Infrared Soldering Condition	260°C For 5 Seconds		
Vapor Phase Soldering Condition	215°C For 3 Minutes		

Note A:

HBM: Human Body Model. Seller gives no other assurances regarding the ability of to withstand ESD. Suggest IR Reflow Condition:



No.: LTST-C171TGKT Page: 2 of 9



Property of Lite-On Only

Electrical Optical Characteristics At Ta=25°C

Parameter	Symbol	Part No. LTST-	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	IV	C171TGKT	50.0	120.0		mcd	IF = 20mA Note 1
Viewing Angle	2 \theta 1/2	C171TGKT		130		deg	Note 2 (Fig.6)
Peak Emission Wavelength	λ Peak	C171TGKT		525		nm	Measurement @Peak (Fig.1)
Dominant Wavelength	λd	C171TGKT		530		nm	Note 3
Spectral Line Half-Width	Δλ	C171TGKT		35		nm	
Forward Voltage	VF	C171TGKT		3.4	3.8	V	IF = 20mA
Reverse Current	IR	C171TGKT			100	μ A	VR = 5V

Notes: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

- 2. θ 1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength, λ d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
- 4. Caution in ESD:

Static Electricity and surge damages the LED. It is recommend to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

Part No.: LTST-C171TGKT Page: 3 of 9



Property of Lite-On Only

Bin Code List

Luminous Inte	ensity Unit:	Unit: mcd @20mA	
Bin Code	Min.	Max.	
P2	50.0	80.0	
Q1	63.0	100.0	
Q2	80.0	125.0	
R1	100.0	160.0	
R2	125.0	200.0	
S1	160.0	250.0	

9 Part No.: LTST-C171TGKT Page: 4 of

Property of Lite-On Only

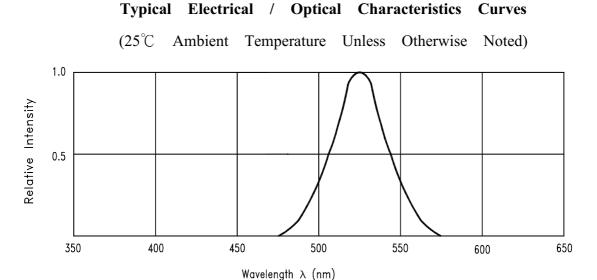
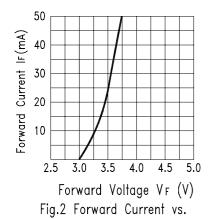
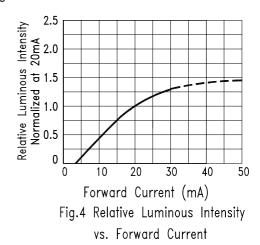


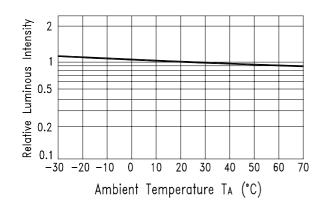
Fig.1 Relative Intensity vs. Wavelength



Forward Voltage

60 50 10 0 20 40 40 40 40 40 40 40 40 60 80 100 Ambient Temperature TA (°C) Fig.3 Forward Current Derating Curve





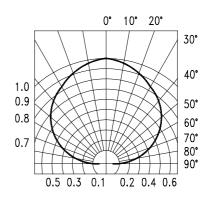


Fig.5 Luminous Intensity vs.

Ambient Temperature

Fig.6 Spatial Distribution

Part No.: LTST-C171TGKT Page: 5 of 9

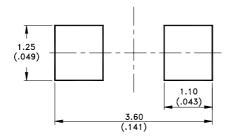


Property of Lite-On Only

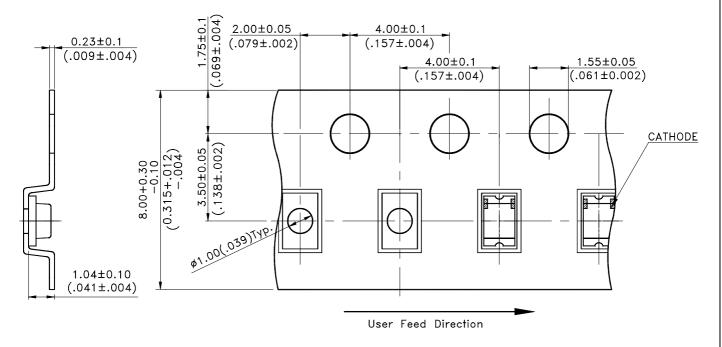
Cleaning

Do not use unspecified chemical liquid to clean LED they could harm the package. If clean is necessary, immerse the LED in ethyl alcohol or in isopropyl alcohol at normal temperature for less one minute.

Suggest Soldering Pad Dimensions



Package Dimensions Of Tape And Reel



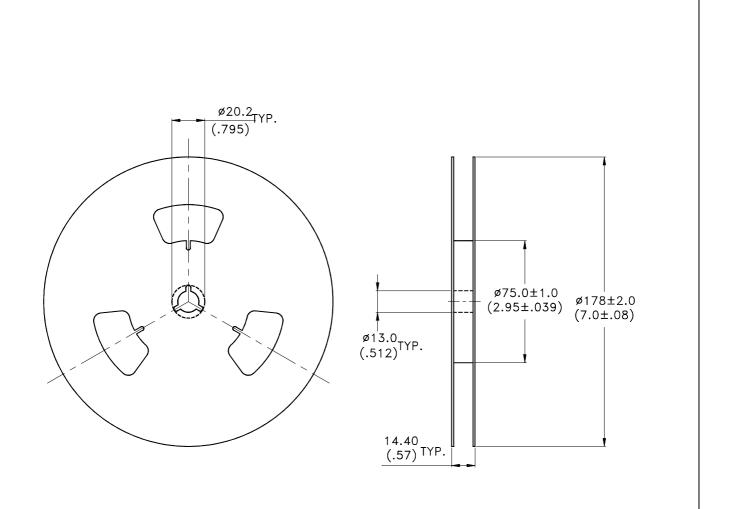
Notes:

1. All dimensions are in millimeters (inches).

No.: LTST-C171TGKT Page: 6 of 9



Property of Lite-On Only



Notes:

- 1. Empty component pockets sealed with top cover tape.
- 2. 7 inch reel-3000 pieces per reel.
- 3. Minimum packing quantity is 500 pcs for remainders
- 4. The maximum number of consecutive missing lamps is two.
- 5. In accordance with ANSI/EIA 481-1-A-1994 specifications.

Part No.: LTST-C171TGKT	Page: 7	of	9	
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Property of Lite-On Only

CAUTIONS

1. Application limitation

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household application.) Consult Liteon's sales in advance for information on application in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as airplanes, automobiles, traffic control equipment, life support system and safety devices).

2. Storage

Before opening the package: The LEDs should be kept at 30°C or less and 85%RH or less. The LEDs

should be used within a year.

After opening the package: The LEDs should be kept at 30°C or less and 70%RH or less. The LEDs

should be soldered within 168 hours(7 days) after opening the package.

Please avoid rapid transitions in ambient temperature in high humidity environments where condensation may occur.

3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED.

4. Soldering

Do not apply any stress to the lead frame during soldering while the LED is at high temperature. Recommended soldering condition

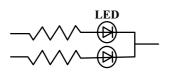
Reflow so	ldering	Solder	ring iron	Wave s	oldering
Pre-heat Pre-heat time Peak temperature	120~150°C 120 sec. Max. 240°C Max.	Temperature Soldering time	300°C Max. 3 sec. Max. (one time only)	Pre-heat Pre-heat time Solder wave	100°C Max. 60 sec. Max. 260°C Max.
Soldering time	10 sec. Max.			Soldering time	10 sec. Max.

5. Drive Method

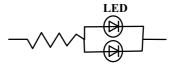
LED is a current operated device, and therefore, requires some kind of current limiting incorporated into the drive circuit. This current limiting typically takes the form of a current limiter resistor placed in series with the LED.

Consider worst case voltage variations that could occur across the current limiting resistor. The forward current should not be allowed to change by more than 40% of its desired value.

Circuit model A



Circuit model B



- (A) Recommended circuit.
- (B) The difference of brightness between LEDs could be found due to the Vf-If characteristics of LED.

Part No.: LTST-C171TGKT Page: of 9



Property of Lite-On Only

6. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or antielectrostatic glove is recommended when handling these LED. All devices, equipment and machinery must be properly grounded.

7. Reliability Test

Classification	Test Item	Test Condition	Referance Standard
	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating *Test Time= 1000HRS (-24HRS,+72HRS)*@20mA.	MIL-STD-750D:1026 (1995) MIL-STD-883D:1005 (1991) JIS C 7021:B-1 (1982)
Endurance Test	High Temperature High Humidity Storage	IR-Reflow In-Board, 2 Times Ta= 65±5°C,RH= 90∼95% *Test Time= 1000HRS±2HRS	MIL-STD-202F:103B(1980) JIS C 7021:B-11(1982)
	High Temperature Storage	Ta= 105±5°C *Test Time= 1000HRS (-24HRS,+72HRS)	MIL-STD-883D:1008 (1991) JIS C 7021:B-10 (1982)
	Low Temperature Storage	Ta= -55±5°C *Test Time=1000HRS (-24HRS,+72H RS)	JIS C 7021:B-12 (1982)
	Temperature Cycling	$105^{\circ}\text{C} \sim 25^{\circ}\text{C} \sim -55^{\circ}\text{C} \sim 25^{\circ}\text{C}$ 30mins 5mins 30mins 5mins 100 Cycles	MIL-STD-202F:107D (1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1010 (1991) JIS C 7021:A-4(1982)
	Thermal Shock	IR-Reflow In-Board, 2 Times $105 \pm 5^{\circ}\text{C} \sim -55^{\circ}\text{C} \pm 5^{\circ}\text{C}$ 10mins 100 Cycles	MIL-STD-202F:107D(1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1011 (1991)
Environmental Test	Solder Resistance	T.sol= $260 \pm 5^{\circ}$ C Dwell Time= 10 ± 1 secs	MIL-STD-202F:210A(1980) MIL-STD-750D:2031(1995) JIS C 7021:A-1(1982)
	IR-Reflow	Ramp-up rate(183°C to Peak) +3°C second max Temp. maintain at 125(±25)°C 120 seconds max Temp. maintain above 183°C 60-150 seconds Peak temperature range 235°C+5/-0°C Time within 5°C of actual Peak Temperature (tp) 10-30 seconds Ramp-down rate +6°C/second max	MIL-STD-750D:2031.2(1995) J-STD-020(1999)
	Solderability	T.sol= 235 ± 5 °C Immersion time 2 ± 0.5 sec Immersion rate 25 ± 2.5 mm/sec Immersion rate 25 ± 2.5 mm/sec Coverage ≥ 95 % of the dipped surface	MIL-STD-202F:208D(1980) MIL-STD-750D:2026(1995) MIL-STD-883D:2003(1991) IEC 68 Part 2-20 JIS C 7021:A-2(1982)

8. Others

The appearance and specifications of the product may be modified for improvement without notice.